## SPAFD7

## SSDCA3138AF

Spectrum Device

## Spread Spectrum Clock Generator Ultra Low Power Mobile EMI Reduction IC SSDCA3138AF

## ■ DESCRIPTION

The SSDCA3138AF is a versatile $1 x$ spread spectrum frequency modulator designed to reduce electromagnetic interference (EMI) clock and data source, allowing system wide reduction of EMI of down stream clock and data dependent signals. The SSDCA3138AF allows significant system cost savings by reducing the number of circuit board layers ferrite beads, shielding and other passive components that are traditionally required to pass EMI regulations.
The SSDCA3138AF family of mobile active EMI management ICs are unique in their design by elimiating the use of conventional PLLs. This allows operation on aperiodic as well periodic signals. The peak energy is distributed over a wider and controlled energy band thereby significantly lowering system

EMI compared to the typical narrow band signal produced by oscillators and most frequency generators. Lowering EMI by increasing a signal's bandwidth is known as "Spread Spectrum" or active EMI management.

3138 has an input frequency range of 10 MHZ to 60 MHz over a wide voltage range of 1.65 V to 3.6 V and generates a $1 x$ spread spectrum coutput. The device can be placed in "power save mode" by setting the PDB pin to GND where in it draws typically 0.1 uA and also stes the MODOUT pin to a High-Z state. The device has to "deviation control pins" SS1 and SS0 to allow flexibility and optimization of both EMI compliance as well in system design.

## - FEATURE

- FCC approved method of EMI attenuation.
- Generates a 1X low EMI spread spectrum clock of the input frequency.
- Input / Output frequency
- VDD $1.65 \mathrm{~V}-3.6 \mathrm{~V} 10 \mathrm{MHz}$ to 60 MHz
- Multiple Deviation Selections
- (Refer product table)
- Power save mode
- 8-pin TDFN package
- Operating Temperature $-40^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$


## Application

3138 is targeted for consumer electronics application such as MFP, STB, DSC, MID,

HDMI,LCD panel Camcorder, and other timing sensitive analog video imaging applications Applications of HDMI, RJ45 port has good compatibility


BLOCK DIAGRAM


SSDCA3138AF block

## PIN ASSIGNMENT



## PIN DESCRIPTION

| Pin name | I/O | Pin no. | Description |
| :---: | :---: | :---: | :--- |
| XIN / CKIN | I | 1 | Clock input pin (or External reference clock input). |
| CKOUT | O | 2 | Crystal connection( external reference, this pin should be left open) |
| SSON | I | 3 | ModCK OUT ON/OFF 1=ON 0=OFF |
| GND | --- | 4 | GND pin |
| ModCK OUT | O | 5 | Modulation clock output |
| ADS | I | 6 | Analog Deviation Selection(refer Functionality Table) |
| ADS | I | 7 | Analog Deviation Selection(refer Functionality Table) |
| VDD | --- | 8 | Power supply voltage pin |

## ABSOLUTE MAXIMUM RATINGS

| Parameter | Symbol | Rating |  | Unit |
| :---: | :---: | :---: | :---: | :---: |
|  |  | Min | Max |  |
| Power supply voltage* | Vdd | -0.5 | + 4.5 | V |
| Input voltage* | V | Vss - 0.5 | $V_{\text {DD }}+0.5$ | V |
| Output voltage* | Vo | Vss - 0.5 | VDD +0.5 | V |
| Storage temperature | Tst | - 55 | + 150 | ${ }^{\circ} \mathrm{C}$ |
| Operation junction temperature | TJ | -40 | +125 | ${ }^{\circ} \mathrm{C}$ |
| Output current | lo | 2 | 4 | mA |
| Overshoot | Viover | - | VDD +1.0 (tover $\leq 4 \mathrm{~ns}$ ) | V |
| Undershoot | Viunder | Vss - 1.0 (tunder $\leq 4 \mathrm{~ns}$ ) | - | V |

*: The parameter is based on $\mathrm{V} s \mathrm{~s}=0.0 \mathrm{~V}$.
WARNING: Semiconductor devices can be permanently damaged by application of stress (voltage, current, temperature, etc.) in excess of absolute maximum ratings. Do not exceed these ratings.

Overshoot/Undershoot


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■ ELECTRICAL CHARACTERISTICS

- DC Characteristics

| $\left(\mathrm{Ta}=-40^{\circ} \mathrm{C}\right.$ to $+125^{\circ} \mathrm{C}, \mathrm{V} \mathrm{DD}=3.3 \mathrm{~V} \pm 0.3 \mathrm{~V}, \mathrm{~V}$ ss $\left.=0.0 \mathrm{~V}\right)$ |  |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Parameter | Symbol | Pin | Conditions | Value |  |  | Unit |
|  |  |  |  | Min | Typ | Max |  |
| Output voltage | Vor | CKOUT | "H" level output Іон $=-4 \mathrm{~mA}$ | 0.66Vbd | - | Vdo | V |
|  | Vol | CKOUT | "L" level output $\mathrm{loL}=4 \mathrm{~mA}$ | Vss | - | 0.33VDd | V |
| Output impedance | Zo | CKOUT | 10 MHz to 60 MHz | - | 30 | - | $\Omega$ |
| Input capacitance | Cin | CKIN, | $\begin{aligned} & \mathrm{Ta}=+25^{\circ} \mathrm{C}, \\ & \mathrm{VDD}=\mathrm{V}_{1}=0.0 \mathrm{~V}, \\ & \mathrm{f}=1 \mathrm{MHz} \end{aligned}$ | - | - | 16 | pF |
| Load capacitance | CL | CKOUT | 10 MHz to 60 MHz | - | - | 10 | pF |
| Power supply current | Icc | Vdo | No load capacitance at 27 MHz | - | 3.0 | 4 | mA |
| Power down current | Ipd | Vdo | Input clock stopping | - | 4 | - | $\mu \mathrm{A}$ |

- AC Characteristics
$\left(\mathrm{Ta}=-40^{\circ} \mathrm{C}\right.$ to $\left.+125^{\circ} \mathrm{C}, \mathrm{V} \mathrm{DD}=3.3 \mathrm{~V} \pm 0.3 \mathrm{~V}, \mathrm{Vss}=0.0 \mathrm{~V}\right)$

| Parameter | Symbol | Pin | Conditions | Value |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min | Typ | Max |  |
| Input frequency | $\mathrm{fin}^{\text {in }}$ | CKIN | - | 10.0 | - | 60 | MHz |
| Output frequency | fout | CKOUT | - | 10.0 | - | 60 | MHz |
| Output slew rate | SR | CKOUT | Load capacitance 15 pF 0.4 V to 2.4 V | 0.4 | - | 4.0 | V/ns |
| Output clock duty cycle | tocc | CKOUT | 1.5 V | 45 | - | 55 | \% |
| Output Rise Time |  |  | between $20 \%$ to $80 \%$ |  | 0.9 |  | nS |
| Output Fall Time |  |  | between $80 \%$ to 20\% |  | 0.9 |  | nS |
| Cycle-cycle jitter | tuc | CKOUT | No load capacitance, $\begin{aligned} & \mathrm{Ta}=+25^{\circ} \mathrm{C}, \\ & \mathrm{VDD}=3.3 \mathrm{~V} \end{aligned}$ | - | - | 40 | ps-rms |

Note : The modulation clock stabilization wait time is required after the power is turned on, the IC recovers from power saving, or after ENS (modulation ON/OFF) setting is changed. For the modulation clock stabilization wait time, assign the maximum value for lock-up time.

OUTPUT CLOCK DUTY CYCLE ( $\mathbf{t} \mathbf{t c c}=\mathbf{t}_{\mathbf{b}} / \mathbf{t a}_{\mathbf{a}}$ )


INPUT FREQUENCY ( $\mathrm{f}_{\mathrm{in}}=1 / \mathrm{t}_{\mathrm{in}}$ )


## OUTPUT SLEW RATE (SR)



Note: $\mathrm{SR}=(2.4-0.4) / \mathrm{tr}, \mathrm{SR}=(2.4-0.4) / \mathrm{t}_{\mathrm{t}}$

## SPREDT

Spectrum Device

## Functional Table

| Vdd(V) | Freq. Range (MHz) | Freq. <br> (MHz) | Deviation (\%) |  |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | SS1 | SS0 | SS1 | SS0 | SS1 | SSO | SS1 | SS0 |
|  |  |  | 0 | 0 | 0 | 1 | 1 | 0 | 1 | 1 |
| 1.8 | 10~33 | 12 | $\pm 0.05$ |  | $\pm 0.10$ |  | $\pm 0.14$ |  | $\pm 0.18$ |  |
| 1.8 |  | 24 | $\pm 0.06$ |  | $\pm 0.12$ |  | $\pm 0.15$ |  | - |  |
| 1.8 |  | 27 | $\pm 0.07$ |  | $\pm 0.13$ |  | $\pm 0.13$ |  | - |  |
| 1.8 |  | 32 | $\pm 0.08$ |  | - |  | - |  | - |  |
| 3.3 | 10~60 | 12 | $\pm 0.03$ |  | $\pm 0.06$ |  | $\pm 0.09$ |  | $\pm 0.11$ |  |
| 3.3 |  | 24 | $\pm 0.05$ |  | $\pm 0.10$ |  | $\pm 0.13$ |  | $\pm 0.16$ |  |
| 3.3 |  | 27 | $\pm 0.06$ |  | $\pm 0.12$ |  | $\pm 0.15$ |  | $\pm 0.17$ |  |
| 3.3 |  | 32 | $\pm 0.06$ |  | $\pm 0.12$ |  | $\pm 0.15$ |  | $\pm 0.17$ |  |

Note: Frequency deviation can vary over voltage and temperature by 5\%

- Center spread

Spectrum is spread (modulated) by centering on the input frequency.


## Spectrum Device

- Diagram of CLK spread



## Spectrum Device

## TDFN-2×2-8L



VDFN/WDFN


| VDEC OUTNE | MO-229 |  |  |
| :---: | :---: | :---: | :---: |
| PKG CODE | WDFN(X208) |  |  |
| SYMBOLS | MIN. | NOM. | MAX. |
| A | 0.70 | 0.75 | 0.80 |
| A1 | 0.00 | 0.02 | 0.05 |
| A3 | 0.203 REF. |  |  |
| b | 0.20 | 0.25 | 0.30 |
| D | 2.00 BSC |  |  |
| E | 2.00 BSC |  |  |
| e | 0.50 BSC |  |  |
| K | 0.20 | - | - |

NOTES :

1. ALL DIMENSIONS ARE IN MILLIMETERS.
2. DIMENSION b APPLIES TO METALLIZED TERMINAL AND IS MEASURED BETWEEN 0.15 mm AND 0.30 mm FROM THE TERMINAL TIP. IF THE TERMINAL HAS THE OPTIONAL RADIUS ON THE OTHER END OF THE TERMINAL, THE DIMENSION b SHOULD NOT BE MEASURED IN THAT RADIUS AREA.
3. BILATERAL COPLANARITY ZONE APPLIES TO THE EXPOSED HEAT SINK SLUG AS WELL AS THE TERMINALS.

|  | D2 |  |  | E2 |  |  | L |  |  | LEAD FINISH |  | JEDEC CODE | VFN | WORI | UPFN | $\begin{aligned} & \text { TonN } \\ & \text { nati } \end{aligned}$ | $\begin{aligned} & \text { TOFF } \\ & \text { croan } \end{aligned}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| PAD SIZE | MIN. | NOM. | MAX, | MIN. | NOM. | MAX, | MIN. | NOM. | MaX. | Pue In | PPF |  |  |  |  |  |  |
| 2. $399 \times 677$ | 1.15 | 1.20 | 1.25 | 0.60 | 0.65 | 0.70 | 0.20 | 0.35 | 0.45 | V | X | N/A | v | V |  |  |  |


DIMENSIONS: MILLIMETERS
" t " is on universol charocter, which means moybe reploced by specific charocter, the octual chorocter please refers to the bonding dioqrom.

## Ordering Code

| Part Number | Package | Temperature |
| :---: | :---: | :---: |
| SSDCA3138AF-08-CT | 8- pin 2-mm TDFN COL - TAPE \& REEL, Green | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |

## Device Ordering Information



